

# 74HC193; 74HCT193

Presetable synchronous 4-bit binary up/down counter

Rev. 4 — 24 June 2013

Product data sheet

## 1. General description

The 74HC193; 74HCT193 is a 4-bit synchronous binary up/down counter. Separate up/down clocks, CPU and CPD respectively, simplify operation. The outputs change state synchronously with the LOW-to-HIGH transition of either clock input. If the CPU clock is pulsed while CPD is held HIGH, the device will count up. If the CPD clock is pulsed while CPU is held HIGH, the device will count down. Only one clock input can be held HIGH at any time to guarantee predictable behaviour. The device can be cleared at any time by the asynchronous master reset input (MR); it may also be loaded in parallel by activating the asynchronous parallel load input (PL). The terminal count up ( $\overline{\text{TCU}}$ ) and terminal count down ( $\overline{\text{TCD}}$ ) outputs are normally HIGH. When the circuit has reached the maximum count state of 15, the next HIGH-to-LOW transition of CPU will cause  $\overline{\text{TCU}}$  to go LOW.  $\overline{\text{TCU}}$  will stay LOW until CPU goes HIGH again, duplicating the count up clock. Likewise, the TCD output will go LOW when the circuit is in the zero state and the CPD goes LOW. The terminal count outputs can be used as the clock input signals to the next higher order circuit in a multistage counter, since they duplicate the clock waveforms. Multistage counters will not be fully synchronous, since there is a slight delay time difference added for each stage that is added. The counter may be preset by the asynchronous parallel load capability of the circuit. Information present on the parallel data inputs (D0 to D3) is loaded into the counter and appears on the outputs (Q0 to Q3) regardless of the conditions of the clock inputs when the parallel load (PL) input is LOW. A HIGH level on the master reset (MR) input will disable the parallel load gates, override both clock inputs and set all outputs (Q0 to Q3) LOW. If one of the clock inputs is LOW during and after a reset or load operation, the next LOW-to-HIGH transition of that clock will be interpreted as a legitimate signal and will be counted. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{CC}$ .

## 2. Features and benefits

- Input levels:
  - ◆ For 74HC193: CMOS level
  - ◆ For 74HCT193: TTL level
- Synchronous reversible 4-bit binary counting
- Asynchronous parallel load
- Asynchronous reset
- Expandable without external logic
- Complies with JEDEC standard no. 7A
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-A exceeds 200 V.



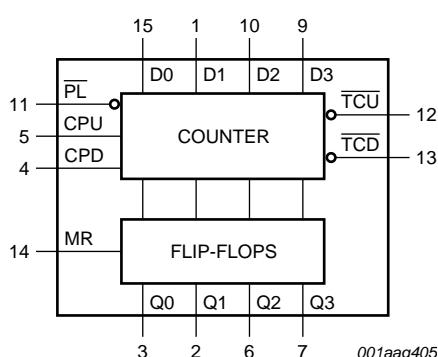
- Multiple package options
- Specified from  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$  and  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

### 3. Ordering information

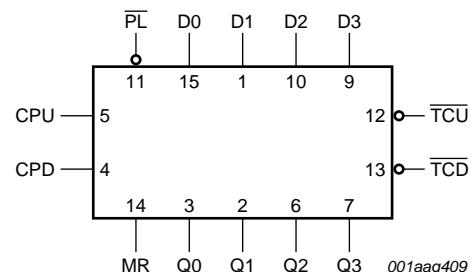
**Table 1. Ordering information**

| Type number | Package | Temperature range                               | Name | Description  | Version  |
|-------------|---------|---|------|--|----------|
| 74HC193D    | SO16    | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic small outline package; 16 leads; body width 3.9 mm             | SOT109-1 |
| 74HC193DB   | SSOP16  | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic shrink small outline package; 16 leads; body width 5.3 mm      | SOT338-1 |
| 74HC193N    | DIP16   | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic dual in-line package; 16 leads (300 mil)                       | SOT38-4  |
| 74HC193PW   | TSSOP16 | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |
| 74HCT193D   | SO16    | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic small outline package; 16 leads; body width 3.9 mm             | SOT109-1 |
| 74HCT193DB  | SSOP16  | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic shrink small outline package; 16 leads; body width 5.3 mm      | SOT338-1 |
| 74HCT193N   | DIP16   | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic dual in-line package; 16 leads (300 mil)                       | SOT38-4  |
| 74HCT193PW  | TSSOP16 | $-40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ |      | plastic thin shrink small outline package; 16 leads; body width 4.4 mm | SOT403-1 |

### 4. Functional diagram



**Fig 1. Functional diagram**



**Fig 2. Logic symbol**

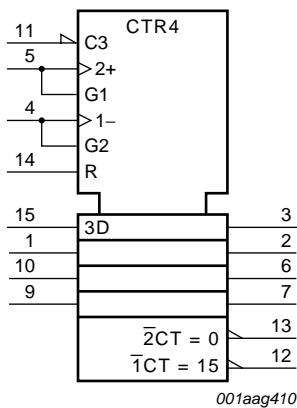


Fig 3. IEC logic symbol

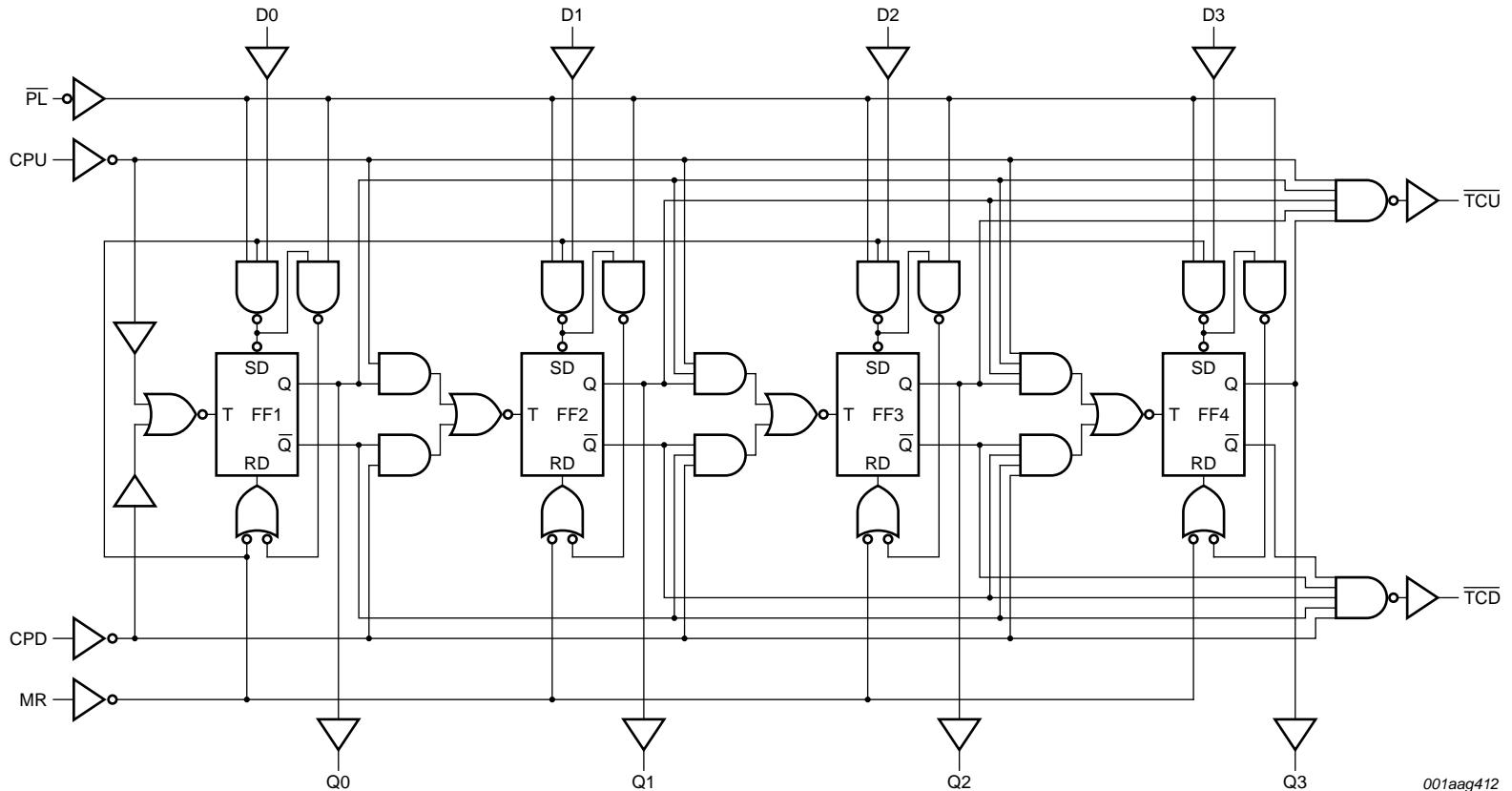


Fig 4. Logic diagram

## 5. Pinning information

### 5.1 Pinning

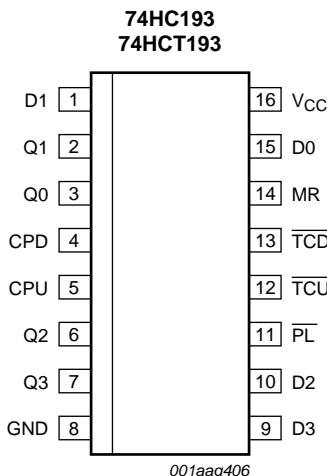


Fig 5. Pin configuration SO16

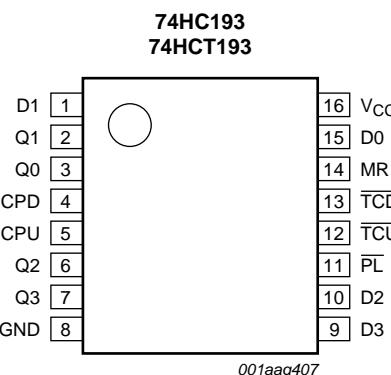


Fig 6. Pin configuration TSSOP16 and SSOP16

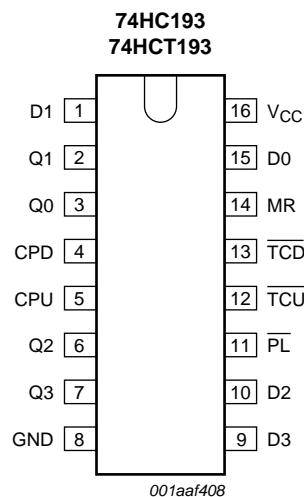


Fig 7. Pin configuration DIP16

### 5.2 Pin description

Table 2. Pin description

| Symbol          | Pin | Description                                      |
|-----------------|-----|--|
| D0              | 15  | data input 0                                     |
| D1              | 1   | data input 1                                     |
| D2              | 10  | data input 2                                     |
| D3              | 9   | data input 3                                     |
| Q0              | 3   | flip-flop output 0                               |
| Q1              | 2   | flip-flop output 1                               |
| Q2              | 6   | flip-flop output 2                               |
| Q3              | 7   | flip-flop output 3                               |
| CPD             | 4   | count down clock input <sup>[1]</sup>            |
| CPU             | 5   | count up clock input <sup>[1]</sup>              |
| GND             | 8   | ground (0 V)                                     |
| PL              | 11  | asynchronous parallel load input (active LOW)    |
| TCU             | 12  | terminal count up (carry) output (active LOW)    |
| TCD             | 13  | terminal count down (borrow) output (active LOW) |
| MR              | 14  | asynchronous master reset input (active HIGH)    |
| V <sub>CC</sub> | 16  | supply voltage                                   |

[1] LOW-to-HIGH, edge triggered.

## 6. Functional description

**Table 3. Function table<sup>[1]</sup>**

| Operating mode | Inputs |                 |            |            |    |    |    |    | Outputs    |    |    |    |                  |                  |
|----------------|--------|-----------------|------------|------------|----|----|----|----|------------|----|----|----|------------------|------------------|
|                | MR     | $\overline{PL}$ | CPU        | CPD        | D0 | D1 | D2 | D3 | Q0         | Q1 | Q2 | Q3 | $\overline{TCU}$ | $\overline{TCD}$ |
| Reset (clear)  | H      | X               | X          | L          | X  | X  | X  | X  | L          | L  | L  | L  | H                | L                |
|                | H      | X               | X          | H          | X  | X  | X  | X  | L          | L  | L  | L  | H                | H                |
| Parallel load  | L      | L               | X          | L          | L  | L  | L  | L  | L          | L  | L  | L  | H                | L                |
|                | L      | L               | X          | H          | L  | L  | L  | L  | L          | L  | L  | L  | H                | H                |
|                | L      | L               | L          | X          | H  | H  | H  | H  | H          | H  | H  | H  | H                | L                |
|                | L      | L               | H          | X          | H  | H  | H  | H  | H          | H  | H  | H  | H                | H                |
| Count up       | L      | H               | $\uparrow$ | H          | X  | X  | X  | X  | count up   |    |    |    | $H^{[2]}$        | H                |
| Count down     | L      | H               | H          | $\uparrow$ | X  | X  | X  | X  | count down |    |    |    | H                | $H^{[3]}$        |

[1] H = HIGH voltage level

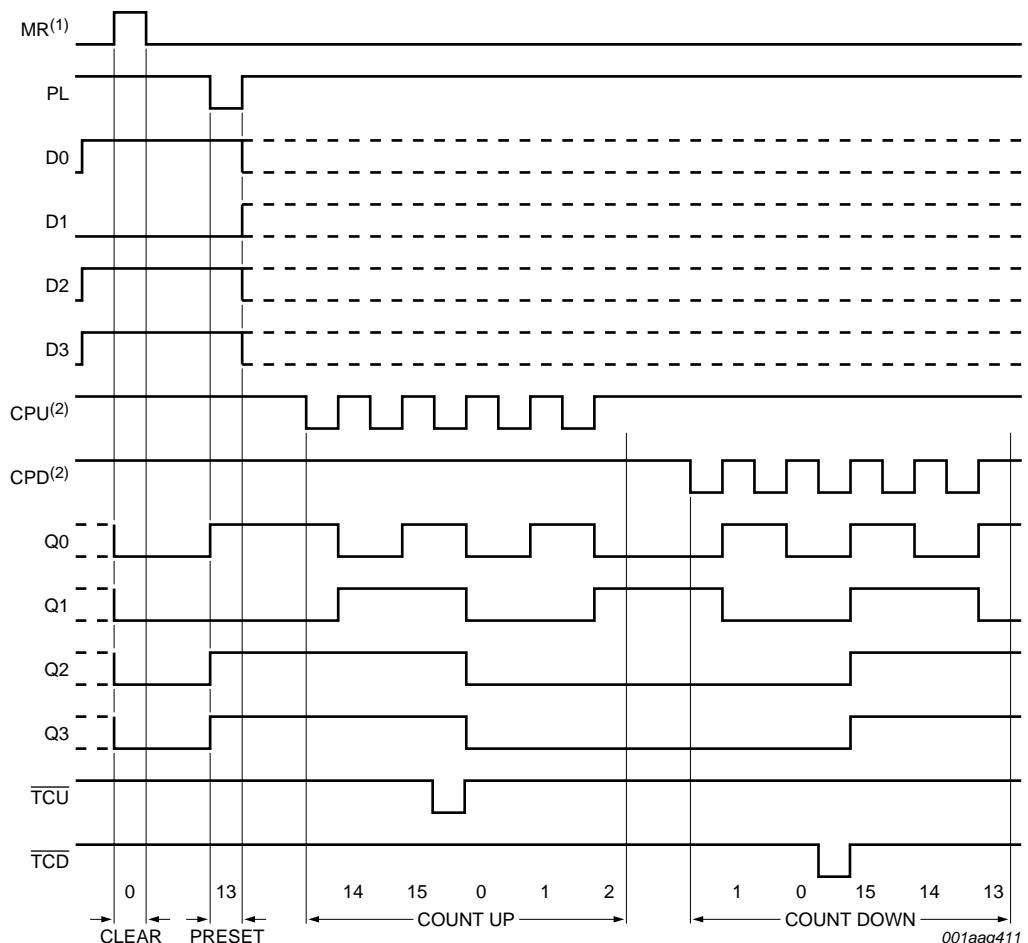
L = LOW voltage level

X = don't care

$\uparrow$  = LOW-to-HIGH clock transition.

[2]  $\overline{TCU}$  = CPU at terminal count up (HHHH)

[3]  $\overline{TCD}$  = CPD at terminal count down (LLLL).



- (1) Clear overrides load, data and count inputs.
- (2) When counting up, the count down clock input (CPD) must be HIGH, when counting down the count up clock input (CPU) must be HIGH.

#### Sequence

Clear (reset outputs to zero);

load (preset) to binary thirteen;

count up to fourteen, fifteen, terminal count up, zero, one and two;

count down to one, zero, terminal count down, fifteen, fourteen and thirteen.

**Fig 8. Typical clear, load and count sequence**

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter               | Conditions  | Min   | Max  | Unit |
|------------------|-------------------------|---|-------|------|------|
| V <sub>CC</sub>  | supply voltage          |   | -0.5  | +7.0 | V    |
| I <sub>IK</sub>  | input clamping current  | V <sub>I</sub> < -0.5 V or V <sub>I</sub> > V <sub>CC</sub> + 0.5 V | [1] - | ±20  | mA   |
| I <sub>OK</sub>  | output clamping current | V <sub>O</sub> < -0.5 V or V <sub>O</sub> > V <sub>CC</sub> + 0.5 V | [1] - | ±20  | mA   |
| I <sub>O</sub>   | output current          | V <sub>O</sub> = -0.5 V to V <sub>CC</sub> + 0.5 V                  | -     | ±25  | mA   |
| I <sub>CC</sub>  | supply current          |   | -     | 50   | mA   |
| I <sub>GND</sub> | ground current          |   | -     | -50  | mA   |
| T <sub>stg</sub> | storage temperature     |   | -65   | +150 | °C   |
| P <sub>tot</sub> | total power dissipation | DIP16 package   | [2] - | 750  | mW   |
|                  |                         | SO16 package  | [2] - | 500  | mW   |
|                  |                         | SSOP16 package  | [2] - | 500  | mW   |
|                  |                         | TSSOP16 package   | [2] - | 500  | mW   |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For DIP16 packages: above 70 °C the value of P<sub>tot</sub> derates linearly at 12 mW/K.

For SO16 packages: above 70 °C the value of P<sub>tot</sub> derates linearly at 8 mW/K.

For SSOP16 and TSSOP16 packages: above 60 °C the value of P<sub>tot</sub> derates linearly at 5.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol           | Parameter                           | Conditions              | Min | Typ  | Max             | Unit |
|------------------|-------------------------------------|-------------------------|-----|------|-----------------|------|
| <b>74HC193</b>   |                                     |                         |     |      |                 |      |
| V <sub>CC</sub>  | supply voltage                      |                         | 2.0 | 5.0  | 6.0             | V    |
| V <sub>I</sub>   | input voltage                       |                         | 0   | -    | V <sub>CC</sub> | V    |
| V <sub>O</sub>   | output voltage                      |                         | 0   | -    | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                         | -40 | +25  | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 2.0 V | -   | -    | 625             | ns/V |
|                  |                                     | V <sub>CC</sub> = 4.5 V | -   | 1.67 | 139             | ns/V |
|                  |                                     | V <sub>CC</sub> = 6.0 V | -   | -    | 83              | ns/V |
| <b>74HCT193</b>  |                                     |                         |     |      |                 |      |
| V <sub>CC</sub>  | supply voltage                      |                         | 4.5 | 5.0  | 5.5             | V    |
| V <sub>I</sub>   | input voltage                       |                         | 0   | -    | V <sub>CC</sub> | V    |
| V <sub>O</sub>   | output voltage                      |                         | 0   | -    | V <sub>CC</sub> | V    |
| T <sub>amb</sub> | ambient temperature                 |                         | -40 | +25  | +125            | °C   |
| Δt/ΔV            | input transition rise and fall rate | V <sub>CC</sub> = 4.5 V | -   | 1.67 | 139             | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics type 74HC193**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                                    | Parameter                 | Conditions   | Min  | Typ  | Max  | Unit |
|---|---------------------------|--|------|------|------|------|
| <b>T<sub>amb</sub> = 25 °C</b>            |                           |  |      |      |      |      |
| V <sub>IH</sub>                           | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5  | 1.2  | -    | V    |
|   |                           | V <sub>CC</sub> = 4.5 V  | 3.15 | 2.4  | -    | V    |
|   |                           | V <sub>CC</sub> = 6.0 V  | 4.2  | 3.2  | -    | V    |
| V <sub>IL</sub>                           | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -    | 0.8  | 0.5  | V    |
|   |                           | V <sub>CC</sub> = 4.5 V  | -    | 2.1  | 1.35 | V    |
|   |                           | V <sub>CC</sub> = 6.0 V  | -    | 2.8  | 1.8  | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    | -    | -    | -    |      |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V                                       | 1.9  | 2.0  | -    | V    |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V                                       | 4.4  | 4.5  | -    | V    |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V                                       | 5.9  | 6.0  | -    | V    |
|   |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V                                      | 3.98 | 4.32 | -    | V    |
|   |                           | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V                                      | 5.48 | 5.81 | -    | V    |
| V <sub>OL</sub>                           | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    | -    | -    | -    |      |
|   |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V  | -    | 0    | 0.1  | V    |
|   |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V  | -    | 0    | 0.1  | V    |
|   |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V  | -    | 0    | 0.1  | V    |
|   |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V                                       | -    | 0.15 | 0.26 | V    |
|   |                           | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V                                       | -    | 0.16 | 0.26 | V    |
| I <sub>I</sub>                            | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V                       | -    | -    | ±0.1 | µA   |
| I <sub>CC</sub>                           | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V | -    | -    | 8.0  | µA   |
| C <sub>i</sub>                            | input capacitance         |  | -    | 3.5  | -    | pF   |
| <b>T<sub>amb</sub> = -40 °C to +85 °C</b> |                           |  |      |      |      |      |
| V <sub>IH</sub>                           | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5  | -    | -    | V    |
|   |                           | V <sub>CC</sub> = 4.5 V  | 3.15 | -    | -    | V    |
|   |                           | V <sub>CC</sub> = 6.0 V  | 4.2  | -    | -    | V    |
| V <sub>IL</sub>                           | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -    | -    | 0.5  | V    |
|   |                           | V <sub>CC</sub> = 4.5 V  | -    | -    | 1.35 | V    |
|   |                           | V <sub>CC</sub> = 6.0 V  | -    | -    | 1.8  | V    |
| V <sub>OH</sub>                           | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    | -    | -    | -    |      |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V                                       | 1.9  | -    | -    | V    |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V                                       | 4.4  | -    | -    | V    |
|   |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V                                       | 5.9  | -    | -    | V    |
|   |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V                                      | 3.84 | -    | -    | V    |
|   |                           | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V                                      | 5.34 | -    | -    | V    |

**Table 6. Static characteristics type 74HC193 ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                                     | Parameter                 | Conditions   | Min  | Typ | Max  | Unit |
|--|---------------------------|--|------|-----|------|------|
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |      |     |      |      |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V                                       | -    | -   | 0.33 | V    |
|  |                           | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V                                       | -    | -   | 0.33 | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V                       | -    | -   | ±1.0 | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V | -    | -   | 80   | µA   |
| <b>T<sub>amb</sub> = -40 °C to +125 °C</b> |                           |  |      |     |      |      |
| V <sub>IH</sub>                            | HIGH-level input voltage  | V <sub>CC</sub> = 2.0 V  | 1.5  | -   | -    | V    |
|  |                           | V <sub>CC</sub> = 4.5 V  | 3.15 | -   | -    | V    |
|  |                           | V <sub>CC</sub> = 6.0 V  | 4.2  | -   | -    | V    |
| V <sub>IL</sub>                            | LOW-level input voltage   | V <sub>CC</sub> = 2.0 V  | -    | -   | 0.5  | V    |
|  |                           | V <sub>CC</sub> = 4.5 V  | -    | -   | 1.35 | V    |
|  |                           | V <sub>CC</sub> = 6.0 V  | -    | -   | 1.8  | V    |
| V <sub>OH</sub>                            | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |      |     |      |      |
|  |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 2.0 V                                       | 1.9  | -   | -    | V    |
|  |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 4.5 V                                       | 4.4  | -   | -    | V    |
|  |                           | I <sub>O</sub> = -20 µA; V <sub>CC</sub> = 6.0 V                                       | 5.9  | -   | -    | V    |
|  |                           | I <sub>O</sub> = -4.0 mA; V <sub>CC</sub> = 4.5 V                                      | 3.7  | -   | -    | V    |
|  |                           | I <sub>O</sub> = -5.2 mA; V <sub>CC</sub> = 6.0 V                                      | 5.2  | -   | -    | V    |
| V <sub>OL</sub>                            | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                    |      |     |      |      |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 2.0 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 4.5 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 20 µA; V <sub>CC</sub> = 6.0 V  | -    | -   | 0.1  | V    |
|  |                           | I <sub>O</sub> = 4.0 mA; V <sub>CC</sub> = 4.5 V                                       | -    | -   | 0.4  | V    |
|  |                           | I <sub>O</sub> = 5.2 mA; V <sub>CC</sub> = 6.0 V                                       | -    | -   | 0.4  | V    |
| I <sub>I</sub>                             | input leakage current     | V <sub>I</sub> = V <sub>CC</sub> or GND; V <sub>CC</sub> = 6.0 V                       | -    | -   | ±1.0 | µA   |
| I <sub>CC</sub>                            | supply current            | V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 6.0 V | -    | -   | 160  | µA   |

**Table 7. Static characteristics type 74HCT193**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol                         | Parameter                 | Conditions  | Min  | Typ  | Max | Unit |
|--------------------------------|---------------------------|---|------|------|-----|------|
| <b>T<sub>amb</sub> = 25 °C</b> |                           |   |      |      |     |      |
| V <sub>IH</sub>                | HIGH-level input voltage  | V <sub>CC</sub> = 4.5 V to 5.5 V  | 2.0  | 1.6  | -   | V    |
| V <sub>IL</sub>                | LOW-level input voltage   | V <sub>CC</sub> = 4.5 V to 5.5 V  | -    | 1.2  | 0.8 | V    |
| V <sub>OH</sub>                | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 4.5 V |      |      |     |      |
|                                |                           | I <sub>O</sub> = -20 µA   | 4.4  | 4.5  | -   | V    |
|                                |                           | I <sub>O</sub> = -4.0 mA  | 3.98 | 4.32 | -   | V    |

**Table 7. Static characteristics type 74HCT193 ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol  | Parameter                 | Conditions  | Min                 | Typ  | Max       | Unit          |
|---|---------------------------|---|---------------------|------|-----------|---------------|
| $V_{OL}$  | LOW-level output voltage  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V   |                     |      |           |               |
|   |                           | $I_O = 20 \mu A$  | -                   | 0    | 0.1       | V             |
|   |                           | $I_O = 4.0$ mA  | -                   | 0.15 | 0.26      | V             |
| $I_I$   | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V   | -                   | -    | $\pm 0.1$ | $\mu A$       |
| $I_{CC}$  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5$ V   | -                   | -    | 8.0       | $\mu A$       |
| $\Delta I_{CC}$                                 | additional supply current | per input pin; $V_I = V_{CC} - 2.1$ V and<br>other inputs at $V_{CC}$ or GND;<br>$I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |                     |      |           |               |
|   |                           |   | pin Dn              | -    | 35        | 126 $\mu A$   |
|   |                           |   | pins CPU, CPD       | -    | 140       | 504 $\mu A$   |
|   |                           |   | pin $\overline{PL}$ | -    | 65        | 234 $\mu A$   |
|   |                           |   | pin MR              | -    | 105       | 378 $\mu A$   |
| $C_i$   | input capacitance         |   | -                   | 3.5  | -         | pF            |
| <b><math>T_{amb} = -40</math> °C to +85 °C</b>  |                           |   |                     |      |           |               |
| $V_{IH}$  | HIGH-level input voltage  | $V_{CC} = 4.5$ V to 5.5 V   | 2.0                 | -    | -         | V             |
| $V_{IL}$  | LOW-level input voltage   | $V_{CC} = 4.5$ V to 5.5 V   | -                   | -    | 0.8       | V             |
| $V_{OH}$  | HIGH-level output voltage | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V   |                     |      |           |               |
|   |                           | $I_O = -20 \mu A$   | 4.4                 | -    | -         | V             |
|   |                           | $I_O = -4.0$ mA   | 3.84                | -    | -         | V             |
| $V_{OL}$  | LOW-level output voltage  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V   |                     |      |           |               |
|   |                           | $I_O = 20 \mu A$  | -                   | -    | 0.1       | V             |
|   |                           | $I_O = 4.0$ mA  | -                   | -    | 0.33      | V             |
| $I_I$   | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V   | -                   | -    | $\pm 1.0$ | $\mu A$       |
| $I_{CC}$  | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5$ V   | -                   | -    | 80        | $\mu A$       |
| $\Delta I_{CC}$                                 | additional supply current | per input pin; $V_I = V_{CC} - 2.1$ V and<br>other inputs at $V_{CC}$ or GND;<br>$I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |                     |      |           |               |
|   |                           |   | pin Dn              | -    | -         | 157.5 $\mu A$ |
|   |                           |   | pins CPU, CPD       | -    | -         | 630 $\mu A$   |
|   |                           |   | pin $\overline{PL}$ | -    | -         | 292.5 $\mu A$ |
|   |                           |   | pin MR              | -    | -         | 472.5 $\mu A$ |
| <b><math>T_{amb} = -40</math> °C to +125 °C</b> |                           |   |                     |      |           |               |
| $V_{IH}$  | HIGH-level input voltage  | $V_{CC} = 4.5$ V to 5.5 V   | 2.0                 | -    | -         | V             |
| $V_{IL}$  | LOW-level input voltage   | $V_{CC} = 4.5$ V to 5.5 V   | -                   | -    | 0.8       | V             |
| $V_{OH}$  | HIGH-level output voltage | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V   |                     |      |           |               |
|   |                           | $I_O = -20 \mu A$   | 4.4                 | -    | -         | V             |
|   |                           | $I_O = -4.0$ mA   | 3.7                 | -    | -         | V             |
| $V_{OL}$  | LOW-level output voltage  | $V_I = V_{IH}$ or $V_{IL}$ ; $V_{CC} = 4.5$ V   |                     |      |           |               |
|   |                           | $I_O = 20 \mu A$  | -                   | -    | 0.1       | V             |
|   |                           | $I_O = 4.0$ mA  | -                   | -    | 0.4       | V             |

**Table 7. Static characteristics type 74HCT193 ...continued**

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol          | Parameter                 | Conditions  | Min | Typ | Max       | Unit    |
|-----------------|---------------------------|---|-----|-----|-----------|---------|
| $I_I$           | input leakage current     | $V_I = V_{CC}$ or GND; $V_{CC} = 5.5$ V   | -   | -   | $\pm 1.0$ | $\mu A$ |
| $I_{CC}$        | supply current            | $V_I = V_{CC}$ or GND; $I_O = 0$ A;<br>$V_{CC} = 5.5$ V   | -   | -   | 160       | $\mu A$ |
| $\Delta I_{CC}$ | additional supply current | per input pin; $V_I = V_{CC} - 2.1$ V and<br>other inputs at $V_{CC}$ or GND;<br>$I_O = 0$ A; $V_{CC} = 4.5$ V to 5.5 V |     |     |           |         |
|                 | pin Dn                    |   | -   | -   | 171.5     | $\mu A$ |
|                 | pins CPU, CPD             |   | -   | -   | 686       | $\mu A$ |
|                 | pin $\overline{PL}$       |   | -   | -   | 318.5     | $\mu A$ |
|                 | pin MR                    |   | -   | -   | 514.5     | $\mu A$ |

## 10. Dynamic characteristics

**Table 8. Dynamic characteristics type 74HC193**

| Symbol   | Parameter   | Conditions  | 25 °C |     |     | −40 °C to +85 °C |     | −40 °C to +125 °C |     | Unit |
|----------|---|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
|          |   |   | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $t_{pd}$ | propagation delay   | CPU, CPD to Qn; see <a href="#">Figure 9</a>  | [1]   | -   |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 63  | 215 | -                | 270 | -                 | 325 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 23  | 43  | -                | 54  | -                 | 65  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 18  | 37  | -                | 46  | -                 | 55  | ns   |
|          |   | CPU to $\overline{\text{TCU}}$ ; see <a href="#">Figure 10</a>                                |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 39  | 125 | -                | 155 | -                 | 190 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 14  | 25  | -                | 31  | -                 | 38  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 11  | 21  | -                | 26  | -                 | 32  | ns   |
|          |   | CPD to $\overline{\text{TCD}}$ ; see <a href="#">Figure 10</a>                                |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 39  | 125 | -                | 155 | -                 | 190 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 14  | 25  | -                | 31  | -                 | 38  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 11  | 21  | -                | 26  | -                 | 32  | ns   |
| $t_{pd}$ | PL to Qn; see <a href="#">Figure 11</a>   | PL to Qn; see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 69  | 220 | -                | 275 | -                 | 330 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 25  | 44  | -                | 55  | -                 | 66  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 20  | 37  | -                | 47  | -                 | 56  | ns   |
|          |   | MR to Qn; see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 58  | 200 | -                | 250 | -                 | 300 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 21  | 40  | -                | 50  | -                 | 60  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 17  | 34  | -                | 43  | -                 | 51  | ns   |
|          |   | Dn to Qn; see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 69  | 210 | -                | 265 | -                 | 315 | ns   |
| $t_{pd}$ | PL to $\overline{\text{TCU}}$ , PL to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a> | $V_{CC} = 4.5 \text{ V}$  | -     | 25  | 42  | -                | 53  | -                 | 63  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 20  | 36  | -                | 45  | -                 | 54  | ns   |
|          |   | PL to $\overline{\text{TCU}}$ , MR to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a> |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 80  | 290 | -                | 365 | -                 | 435 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 29  | 58  | -                | 73  | -                 | 87  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 23  | 49  | -                | 62  | -                 | 74  | ns   |
|          |   | MR to $\overline{\text{TCU}}$ , MR to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a> |       |     |     |                  |     |                   |     |      |
|          |   | $V_{CC} = 2.0 \text{ V}$  | -     | 74  | 285 | -                | 355 | -                 | 430 | ns   |
|          |   | $V_{CC} = 4.5 \text{ V}$  | -     | 27  | 57  | -                | 71  | -                 | 86  | ns   |
|          |   | $V_{CC} = 6.0 \text{ V}$  | -     | 22  | 48  | -                | 60  | -                 | 73  | ns   |

**Table 8. Dynamic characteristics type 74HC193 ...continued**

| Symbol    | Parameter                          | Conditions  | 25 °C |     |     | −40 °C to +85 °C |     | −40 °C to +125 °C |     | Unit |
|-----------|------------------------------------|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
|           |                                    |   | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $t_{pd}$  | propagation delay                  | Dn to $\overline{\text{TCU}}$ , Dn to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a> |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | -     | 80  | 290 | -                | 365 | -                 | 435 | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | -     | 29  | 58  | -                | 73  | -                 | 87  | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | -     | 23  | 49  | -                | 62  | -                 | 74  | ns   |
| $t_{THL}$ | HIGH to LOW output transition time | see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | -     | 19  | 75  | -                | 95  | -                 | 110 | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | -     | 7   | 15  | -                | 19  | -                 | 22  | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | -     | 6   | 13  | -                | 16  | -                 | 19  | ns   |
| $t_{TLH}$ | LOW to HIGH output transition time | see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | -     | 19  | 75  | -                | 95  | -                 | 110 | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | -     | 7   | 15  | -                | 19  | -                 | 22  | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | -     | 6   | 13  | -                | 16  | -                 | 19  | ns   |
| $t_W$     | pulse width                        | CPU, CPD (HIGH or LOW); see <a href="#">Figure 9</a>  |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | 100   | 22  | -   | 125              | -   | 150               | -   | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | 20    | 8   | -   | 25               | -   | 30                | -   | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | 17    | 6   | -   | 21               | -   | 26                | -   | ns   |
|           |                                    | MR (HIGH); see <a href="#">Figure 12</a>  |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | 100   | 25  | -   | 125              | -   | 150               | -   | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | 20    | 9   | -   | 25               | -   | 30                | -   | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | 17    | 7   | -   | 21               | -   | 26                | -   | ns   |
|           |                                    | PL (LOW); see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | 100   | 19  | -   | 125              | -   | 150               | -   | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | 20    | 7   | -   | 25               | -   | 30                | -   | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | 17    | 6   | -   | 21               | -   | 26                | -   | ns   |
| $t_{rec}$ | recovery time                      | PL to CPU, CPD; see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | 50    | 8   | -   | 65               | -   | 75                | -   | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | 10    | 3   | -   | 13               | -   | 15                | -   | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | 9     | 2   | -   | 11               | -   | 13                | -   | ns   |
|           |                                    | MR to CPU, CPD; see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |                                    | $V_{CC} = 2.0 \text{ V}$  | 50    | 0   | -   | 65               | -   | 75                | -   | ns   |
|           |                                    | $V_{CC} = 4.5 \text{ V}$  | 10    | 0   | -   | 13               | -   | 15                | -   | ns   |
|           |                                    | $V_{CC} = 6.0 \text{ V}$  | 9     | 0   | -   | 11               | -   | 13                | -   | ns   |

**Table 8. Dynamic characteristics type 74HC193 ...continued**

| Symbol    | Parameter                     | Conditions   | 25 °C |      |     | −40 °C to +85 °C |     | −40 °C to +125 °C |     | Unit |
|-----------|-------------------------------|--|-------|------|-----|------------------|-----|-------------------|-----|------|
|           |                               |  | Min   | Typ  | Max | Min              | Max | Min               | Max |      |
| $t_{su}$  | set-up time                   | Dn to $\overline{PL}$ ; see<br><a href="#">Figure 13</a> ; note:<br>CPU = CPD =<br>HIGH  |       |      |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 2.0 \text{ V}$   | 80    | 22   | -   | 100              | -   | 120               | -   | ns   |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 16    | 8    | -   | 20               | -   | 24                | -   | ns   |
|           |                               | $V_{CC} = 6.0 \text{ V}$   | 14    | 6    | -   | 17               | -   | 20                | -   | ns   |
| $t_h$     | hold time                     | Dn to $\overline{PL}$ ; see<br><a href="#">Figure 13</a>                                 |       |      |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 2.0 \text{ V}$   | 0     | −14  | -   | 0                | -   | 0                 | -   | ns   |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 0     | −5   | -   | 0                | -   | 0                 | -   | ns   |
|           |                               | $V_{CC} = 6.0 \text{ V}$   | 0     | −4   | -   | 0                | -   | 0                 | -   | ns   |
|           |                               | CPU to CPD,<br>CPD to CPU; see<br><a href="#">Figure 15</a>                              |       |      |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 2.0 \text{ V}$   | 80    | 22   | -   | 100              | -   | 120               | -   | ns   |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 16    | 8    | -   | 20               | -   | 24                | -   | ns   |
|           |                               | $V_{CC} = 6.0 \text{ V}$   | 8     | 6    | -   | 17               | -   | 20                | -   | ns   |
| $f_{max}$ | maximum frequency             | CPU, CPD; see<br><a href="#">Figure 9</a>  |       |      |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 2.0 \text{ V}$   | 4.0   | 13.5 | -   | 3.2              | -   | 2.6               | -   | MHz  |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 20    | 41   | -   | 16               | -   | 13                | -   | MHz  |
|           |                               | $V_{CC} = 6.0 \text{ V}$   | 24    | 49   | -   | 19               | -   | 15                | -   | MHz  |
| $C_{PD}$  | power dissipation capacitance | $V_I = \text{GND to } V_{CC}$ ; [2]<br>$V_{CC} = 5 \text{ V}$ ;<br>$f_i = 1 \text{ MHz}$ |       | -    | 24  | -                | -   | -                 | -   | pF   |

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

$C_L$  = output load capacitance in pF;

$V_{CC}$  = supply voltage in V;

N = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

Table 9. Dynamic characteristics type 74HCT193

| Symbol    | Parameter                               | Conditions  | 25 °C |     |     | −40 °C to +85 °C |     | −40 °C to +125 °C |     | Unit |
|-----------|---|---|-------|-----|-----|------------------|-----|-------------------|-----|------|
|           |   |   | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $t_{pd}$  | propagation delay                       | CPU, CPD to Qn; see <a href="#">Figure 9</a>  | [1]   |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 23  | 43  | -                | 54  | -                 | 65  | ns   |
|           |   | CPU to $\overline{\text{TCU}}$ ; see <a href="#">Figure 10</a>  |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 15  | 27  | -                | 34  | -                 | 41  | ns   |
|           |   | CPD to $\overline{\text{TCD}}$ ; see <a href="#">Figure 10</a>  |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 15  | 27  | -                | 34  | -                 | 41  | ns   |
|           |   | $\overline{\text{PL}}$ to Qn; see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 26  | 46  | -                | 58  | -                 | 69  | ns   |
|           |   | MR to Qn; see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 22  | 40  | -                | 50  | -                 | 60  | ns   |
| $t_{PLH}$ | Dn to Qn; see <a href="#">Figure 11</a> | $\overline{\text{PL}}$ to $\overline{\text{TCU}}$ , $\overline{\text{PL}}$ to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a> |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 27  | 46  | -                | 58  | -                 | 69  | ns   |
|           |   | MR to $\overline{\text{TCU}}$ , MR to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 31  | 55  | -                | 69  | -                 | 83  | ns   |
|           |   | Dn to $\overline{\text{TCU}}$ , Dn to $\overline{\text{TCD}}$ ; see <a href="#">Figure 14</a>   |       |     |     |                  |     |                   |     |      |
| $t_{TLH}$ | HIGH to LOW output transition time      | $V_{CC} = 4.5 \text{ V}$  | -     | 29  | 55  | -                | 69  | -                 | 83  | ns   |
|           |   | see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 32  | 58  | -                | 73  | -                 | 87  | ns   |
|           |   | see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | -     | 7   | 15  | -                | 19  | -                 | 22  | ns   |
| $t_w$     | pulse width                             | MR (HIGH); see <a href="#">Figure 12</a>  |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | 25    | 11  | -   | 31               | -   | 38                | -   | ns   |
|           |   | PL (LOW); see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|           |   | $V_{CC} = 4.5 \text{ V}$  | 20    | 7   | -   | 25               | -   | 30                | -   | ns   |
|           |   | $V_{CC} = 4.5 \text{ V}$  | 20    | 8   | -   | 25               | -   | 30                | -   | ns   |

**Table 9. Dynamic characteristics type 74HCT193 ...continued**

| Symbol    | Parameter                     | Conditions   | 25 °C |     |     | −40 °C to +85 °C |     | −40 °C to +125 °C |     | Unit |
|-----------|-------------------------------|--|-------|-----|-----|------------------|-----|-------------------|-----|------|
|           |                               |  | Min   | Typ | Max | Min              | Max | Min               | Max |      |
| $t_{rec}$ | recovery time                 | PL to CPU, CPD;<br>see <a href="#">Figure 11</a>   |       |     |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 10    | 2   | -   | 13               | -   | 15                | -   | ns   |
| $t_{su}$  | set-up time                   | MR to CPU, CPD;<br>see <a href="#">Figure 12</a>   |       |     |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 10    | 0   | -   | 13               | -   | 15                | -   | ns   |
| $t_h$     | hold time                     | Dn to PL; see<br><a href="#">Figure 13</a> ; note:<br>CPU = CPD =<br>HIGH                |       |     |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 16    | 8   | -   | 20               | -   | 24                | -   | ns   |
| $f_{max}$ | maximum frequency             | Dn to PL; see<br><a href="#">Figure 13</a>   |       |     |     |                  |     |                   |     |      |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 0     | −6  | -   | 0                | -   | 0                 | -   | ns   |
| $C_{PD}$  | power dissipation capacitance | CPU to CPD,<br>CPD to CPU; see<br><a href="#">Figure 15</a>                              |       |     |     |                  |     |                   |     |      |
|           |                               | $V_I = \text{GND to } V_{CC} - 1.5 \text{ V}; V_{CC} = 5 \text{ V}; f_i = 1 \text{ MHz}$ | 16    | 7   | -   | 20               | -   | 24                | -   | ns   |
|           |                               | $V_{CC} = 4.5 \text{ V}$   | 20    | 43  | -   | 16               | -   | 13                | -   | MHz  |

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ):

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

$f_i$  = input frequency in MHz;

$f_o$  = output frequency in MHz;

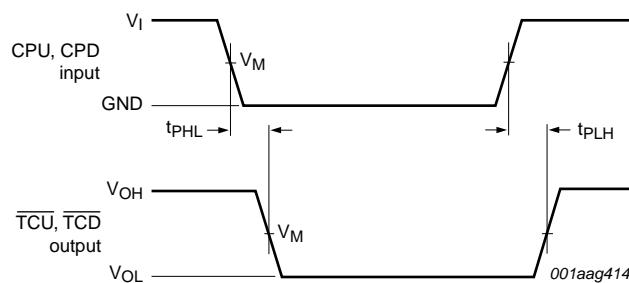
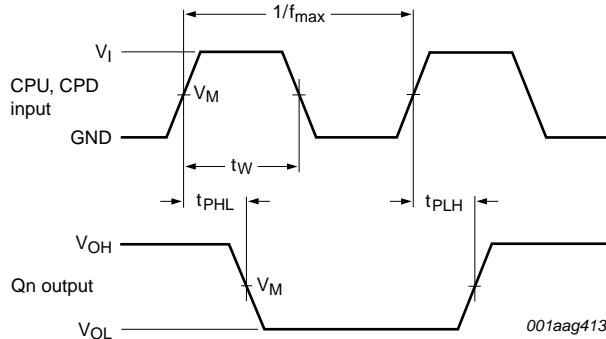
$C_L$  = output load capacitance in pF;

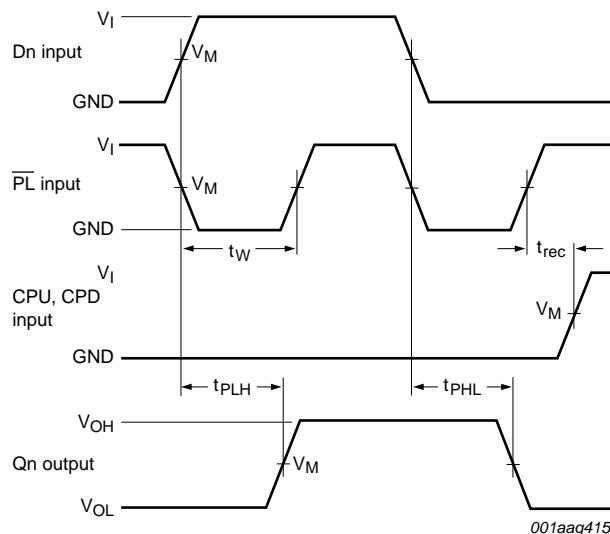
$V_{CC}$  = supply voltage in V;

$N$  = number of inputs switching;

$\sum(C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

## 11. Waveforms



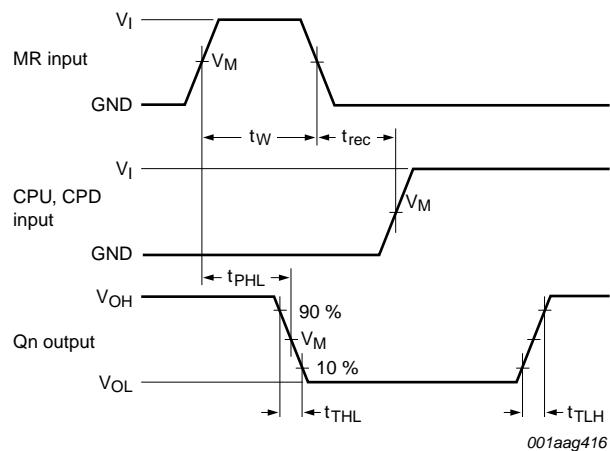


Measurement points are given in [Table 10](#).

t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.

Logic levels V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

**Fig 11. The parallel load input (PL) and data (Dn) to Qn output propagation delays and PL removal time to clock input (CPU, CPD)**

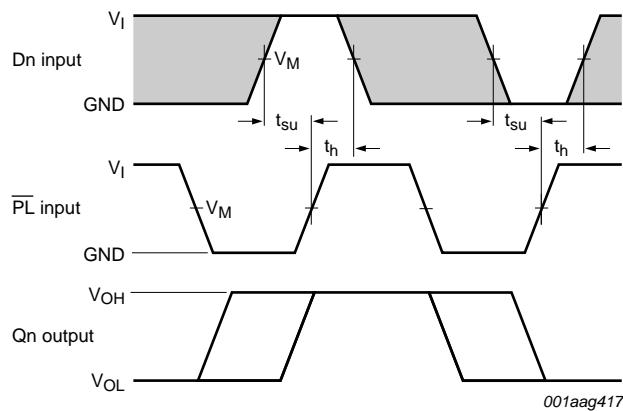


Measurement points are given in [Table 10](#).

t<sub>PLH</sub> and t<sub>PHL</sub> are the same as t<sub>pd</sub>.

Logic levels V<sub>OL</sub> and V<sub>OH</sub> are typical output voltage levels that occur with the output load.

**Fig 12. The master reset input (MR) pulse width, MR to Qn propagation delays, MR to CPU, CPD removal time and output transition times**

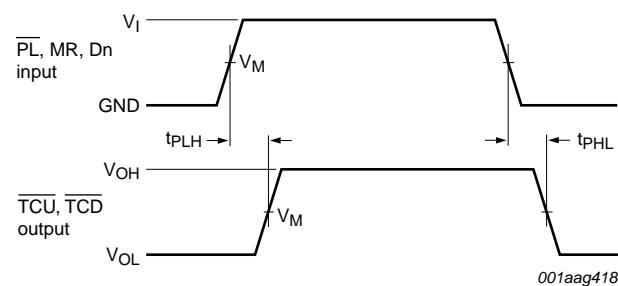


The shaded areas indicate when the input is permitted to change for predictable output performance.

Measurement points are given in [Table 10](#).

Logic levels  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 13. The data input ( $D_n$ ) to parallel load input ( $PL$ ) set-up and hold times**

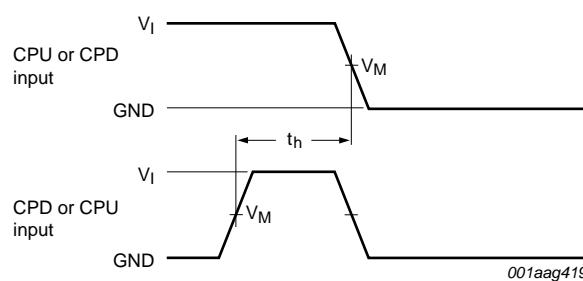


Measurement points are given in [Table 10](#).

$t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

Logic levels  $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 14. The data input ( $D_n$ ), parallel load input ( $PL$ ) and the master reset input ( $MR$ ) to the terminal count outputs ( $TCU$ ,  $TCD$ ) propagation delays**

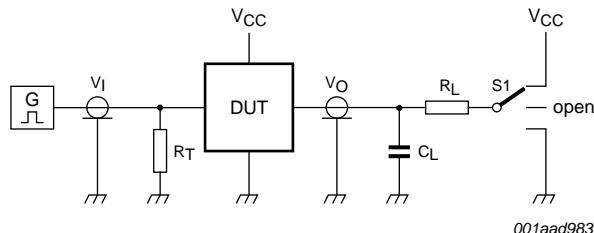
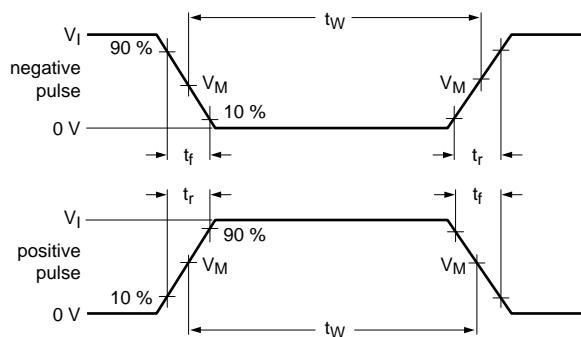


Measurement points are given in [Table 10](#).

**Fig 15. The CPU to CPD or CPD to CPU hold times**

Table 10. Measurement points

| Type     | Input               |                 | Output              |
|----------|---------------------|-----------------|---------------------|
|          | $V_M$               | $V_I$           |                     |
| 74HC193  | $0.5 \times V_{CC}$ | GND to $V_{CC}$ | $0.5 \times V_{CC}$ |
| 74HCT193 | 1.3 V               | GND to 3 V      | 1.3 V               |



001aad983

Test data is given in [Table 11](#).

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator $C_L$  = Load capacitance including jig and probe capacitance $R_L$  = Load resistor

S1 = Test selection switch

Fig 16. Load circuitry for measuring switching times

Table 11. Test data

| Type     | Input    |            | Load         |              | S1 position |
|----------|----------|------------|--------------|--------------|-------------|
|          | $V_I$    | $t_r, t_f$ | $C_L$        | $R_L$        |             |
| 74HC193  | $V_{CC}$ | 6 ns       | 15 pF, 50 pF | 1 k $\Omega$ | open        |
| 74HCT193 | 3 V      | 6 ns       | 15 pF, 50 pF | 1 k $\Omega$ | open        |

## 12. Application information

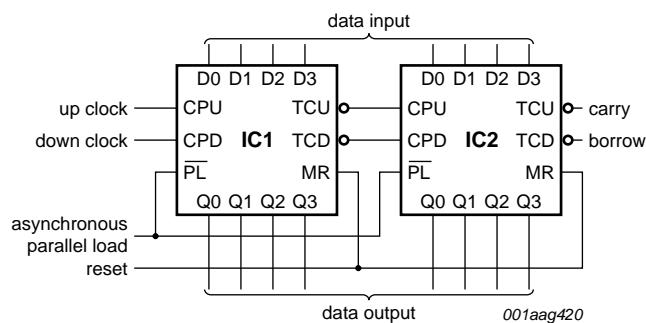
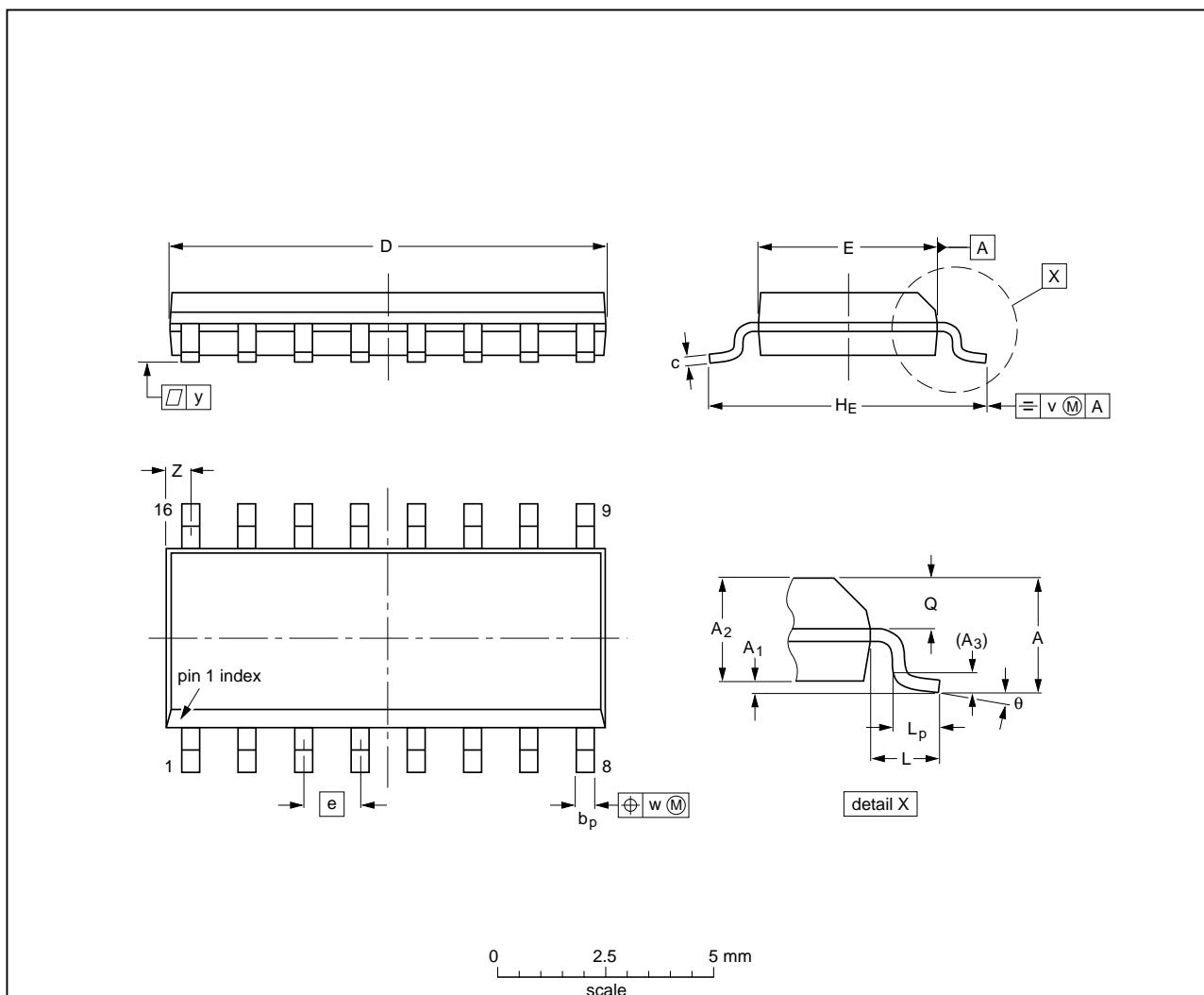


Fig 17. Application for cascaded up/down counter with parallel load

## 13. Package outline

SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max.      | A <sub>1</sub> | A <sub>2</sub> | A <sub>3</sub> | b <sub>p</sub> | c                | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | H <sub>E</sub> | L     | L <sub>p</sub> | Q              | v    | w    | y     | Z <sup>(1)</sup> | θ        |
|--------|----------------|----------------|----------------|----------------|----------------|------------------|------------------|------------------|------|----------------|-------|----------------|----------------|------|------|-------|------------------|----------|
| mm     | 1.75<br>0.10   | 0.25<br>0.36   | 1.45<br>1.25   | 0.25           | 0.49<br>0.36   | 0.25<br>0.19     | 10.0<br>9.8      | 4.0<br>3.8       | 1.27 | 6.2<br>5.8     | 1.05  | 1.0<br>0.4     | 0.7<br>0.6     | 0.25 | 0.25 | 0.1   | 0.7<br>0.3       | 8°<br>0° |
| inches | 0.069<br>0.004 | 0.010<br>0.049 | 0.057<br>0.049 | 0.01           | 0.019<br>0.014 | 0.0100<br>0.0075 | 0.39<br>0.38     | 0.16<br>0.15     | 0.05 | 0.244<br>0.228 | 0.041 | 0.039<br>0.016 | 0.028<br>0.020 | 0.01 | 0.01 | 0.004 | 0.028<br>0.012   | 0°       |

Note

1. Plastic or metal protrusions of 0.15 mm (0.006 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |        |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|--------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC  | JEITA |  |                        |                      |
| SOT109-1           | 076E07     | MS-012 |       |  |                        | 99-12-27<br>03-02-19 |

Fig 18. Package outline SOT109-1 (SO16)

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

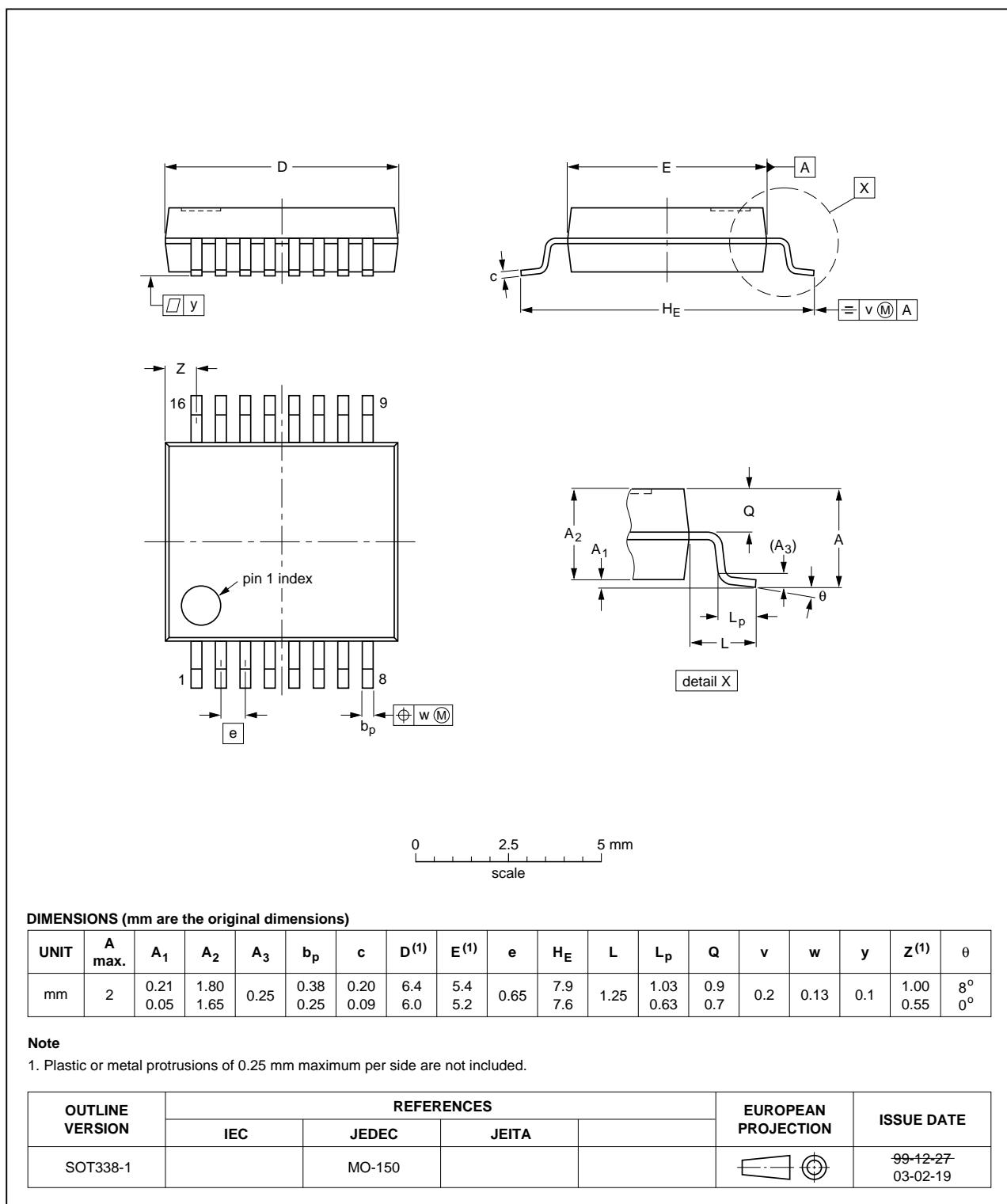
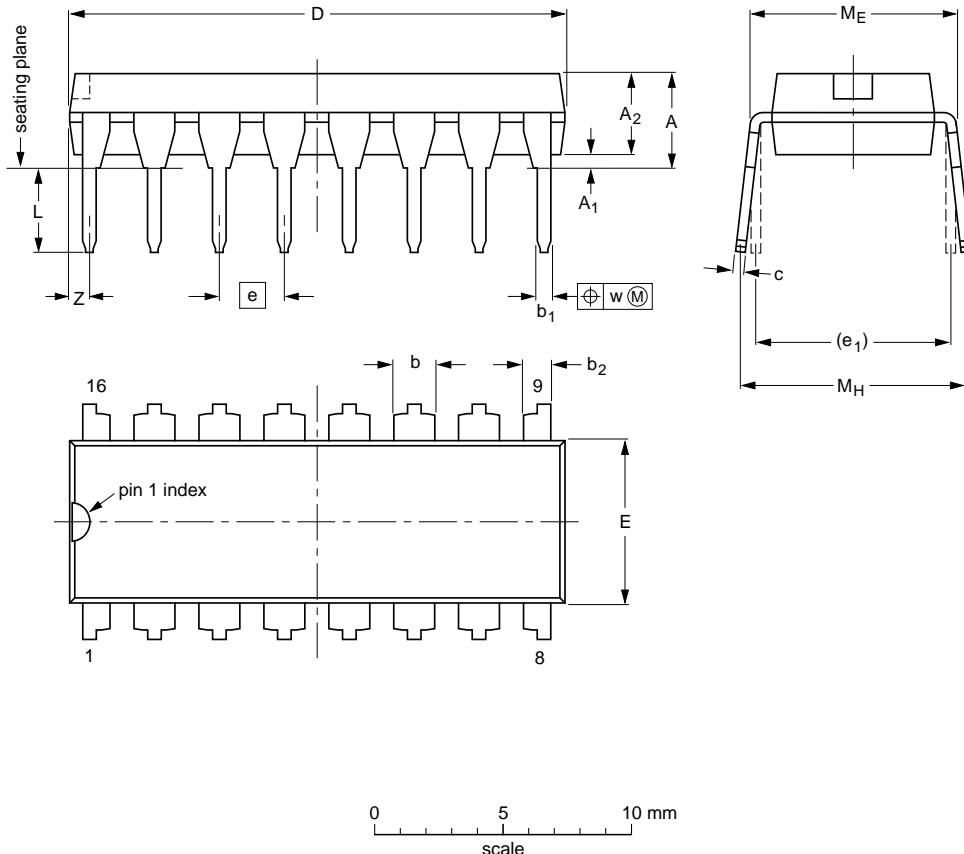


Fig 19. Package outline SOT338-1 (SSOP16)

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



## DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT   | A<br>max. | A <sub>1</sub><br>min. | A <sub>2</sub><br>max. | b              | b <sub>1</sub> | b <sub>2</sub> | c              | D <sup>(1)</sup> | E <sup>(1)</sup> | e    | e <sub>1</sub> | L            | M <sub>E</sub> | M <sub>H</sub> | w     | Z <sup>(1)</sup><br>max. |
|--------|-----------|------------------------|------------------------|----------------|----------------|----------------|----------------|------------------|------------------|------|----------------|--------------|----------------|----------------|-------|--------------------------|
| mm     | 4.2       | 0.51                   | 3.2                    | 1.73<br>1.30   | 0.53<br>0.38   | 1.25<br>0.85   | 0.36<br>0.23   | 19.50<br>18.55   | 6.48<br>6.20     | 2.54 | 7.62           | 3.60<br>3.05 | 8.25<br>7.80   | 10.0<br>8.3    | 0.254 | 0.76                     |
| inches | 0.17      | 0.02                   | 0.13                   | 0.068<br>0.051 | 0.021<br>0.015 | 0.049<br>0.033 | 0.014<br>0.009 | 0.77<br>0.73     | 0.26<br>0.24     | 0.1  | 0.3            | 0.14<br>0.12 | 0.32<br>0.31   | 0.39<br>0.33   | 0.01  | 0.03                     |

## Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

| OUTLINE<br>VERSION | REFERENCES |       |       |  | EUROPEAN<br>PROJECTION | ISSUE DATE           |
|--------------------|------------|-------|-------|--|------------------------|----------------------|
|                    | IEC        | JEDEC | JEITA |  |                        |                      |
| SOT38-4            |            |       |       |  |                        | 95-01-14<br>03-02-13 |

Fig 20. Package outline SOT38-4 (DIP16)

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

SOT403-1

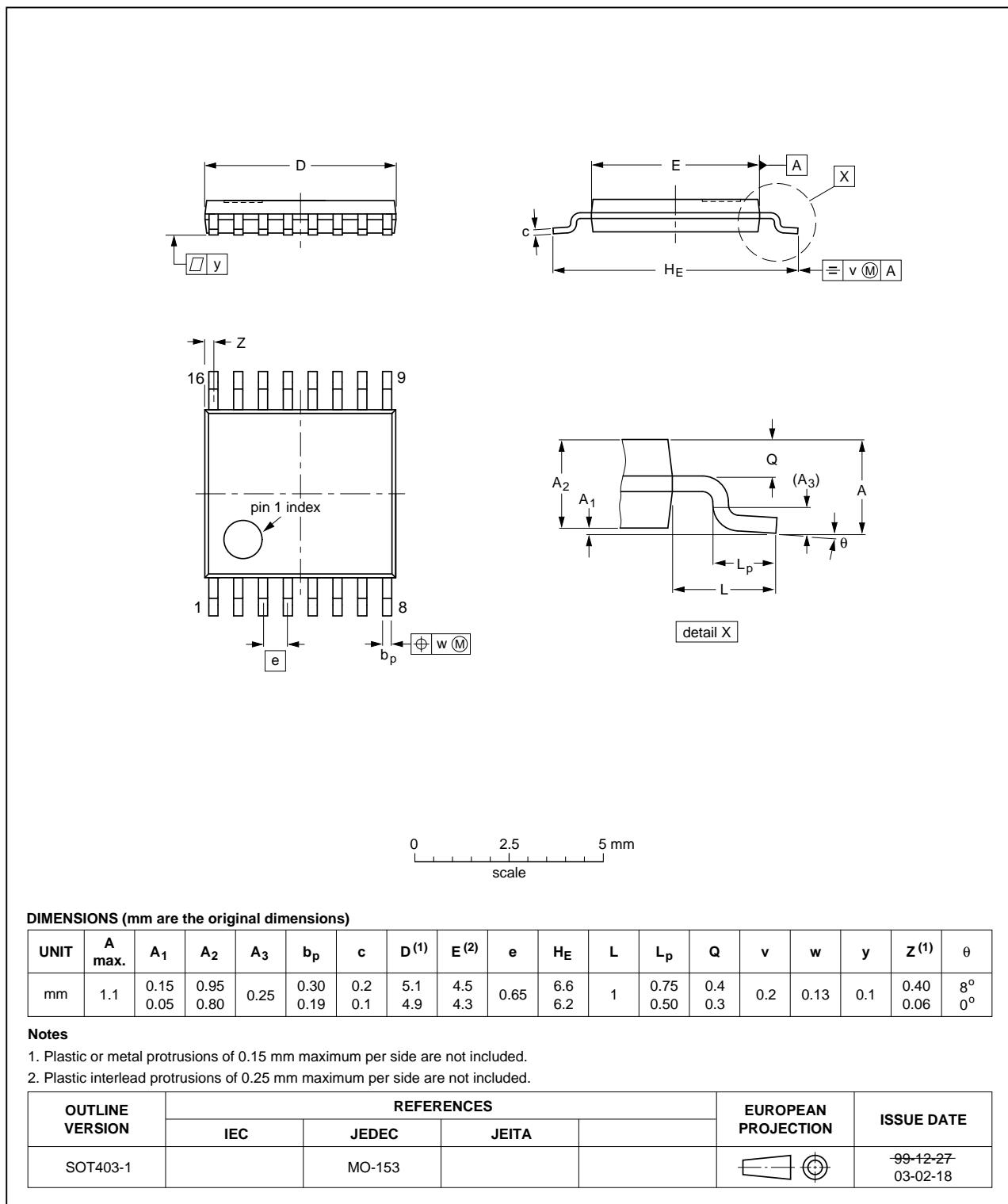


Fig 21. Package outline SOT403-1 (TSSOP16)

## 14. Abbreviations

**Table 12. Abbreviations**

| Acronym | Description                                    |
|---------|--|
| CMOS    | Complementary Metal-Oxide Semiconductor        |
| DUT     | Device Under Test                              |
| ESD     | ElectroStatic Discharge                        |
| HBM     | Human Body Model                               |
| LSTTL   | Low-power Schottky Transistor-Transistor Logic |
| MM      | Machine Model                                  |
| TTL     | Transistor-Transistor Logic                    |

## 15. Revision history

**Table 13. Revision history**

| Document ID         | Release date | Data sheet status  | Change notice | Supersedes          |
|---------------------|--------------|--|---------------|---------------------|
| 74HC_HCT193 v.4     | 20130624     | Product data sheet   | -             | 74HC_HCT193 v.3     |
| Modifications:      |              | • General description updated.   |               |                     |
| 74HC_HCT193 v.3     | 20070523     | Product data sheet   | -             | 74HC_HCT193_CNV v.2 |
| Modifications:      |              | • The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.<br>• Legal texts have been adapted to the new company name where appropriate.<br>• Family specification included |               |                     |
| 74HC_HCT193_CNV v.2 | 19970828     | Product specification  | -             | -                   |

## 16. Legal information

### 16.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition  |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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